

### STP120N4F6

# N-channel 40 V, 3.8 mΩ, 80 A, TO-220 STripFET™ VI DeepGATE™ Power MOSFET

#### **Features**

Order code	V <sub>DSS</sub>	R <sub>DS(on)</sub> max.	I <sub>D</sub>
STP120N4F6	40 V	$4.3~\text{m}\Omega$	80 A <sup>(1)</sup>

- 1. Current limited by package
- Standard threshold drive
- 100% avalanche tested

#### **Application**

- Switching applications
- Automotive



This device is a 40 V N-channel STripFET<sup>TM</sup> VI Power MOSFET based on the ST's proprietary STripFET<sup>TM</sup> technology, with a new gate structure. The resulting Power MOSFET exhibits the lowest  $R_{DS(on)}$  in all packages.

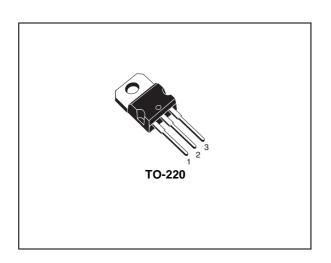


Figure 1. Internal schematic diagram

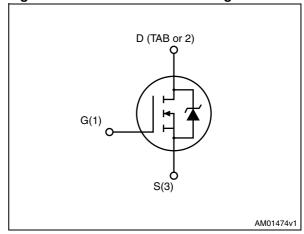


Table 1. Device summary

Order code	Marking	Package	Packaging
STP120N4F6	120N4F6	TO-220	Tube

Contents STP120N4F6

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STP120N4F6 Electrical ratings

# 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage (V <sub>GS</sub> = 0)	40	V
$V_{GS}$	Gate-source voltage	± 20	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25 °C	80	Α
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 100 °C	80	Α
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	320	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	110	W
T <sub>stg</sub>	Storage temperature	-55 to 175	°C
T <sub>j</sub>	Operating junction temperature	-55 to 175	O

<sup>1.</sup> Current limited by package

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case max	1.36	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-amb max	62.5	°C/W

Table 4. Thermal resistance

Symbol	Parameter	Value	Unit
I <sub>AR</sub> <sup>(1)</sup>	Avalanche current, repetitive or not-repetitive	40	Α
E <sub>AS</sub> (2)	Single pulse avalanche energy	394	mJ

<sup>1.</sup> Pulse width limited by Tj max

<sup>2.</sup> Pulse width limited by safe operating area

<sup>2.</sup> Starting Tj = 25 °C,  $I_D$  = 40 A,  $V_{DD}$  = 25 V

Electrical characteristics STP120N4F6

## 2 Electrical characteristics

 $(T_{CASE} = 25 \, ^{\circ}C \text{ unless otherwise specified})$ 

Table 5. Static

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown Voltage	$I_D = 250 \ \mu\text{A}, \ V_{GS} = 0$	40			V
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	V <sub>DS</sub> = 20 V V <sub>DS</sub> = 20 V,Tc = 125 °C			1 10	μ <b>Α</b> μ <b>Α</b>
I <sub>GSS</sub>	Gate body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ± 20 V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2		4	V
R <sub>DS(on)</sub>	Static drain-source on resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 40 A		3.8	4.3	mΩ

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min	Тур.	Max.	Unit
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	V <sub>DS</sub> = 25 V, f=1 MHz, V <sub>GS</sub> = 0 V	-	3850 650 350	-	pF pF pF
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total gate charge Gate-source charge Gate-drain charge	$V_{DD}$ = 20 V, $I_{D}$ = 80 A $V_{GS}$ = 10 V (see Figure 14)	-	65 20 16	-	nC nC nC
R <sub>G</sub>	Intrinsic gate resistance	f = 1 MHz open drain	-	1.5	-	Ω

Table 7. Switching on/off (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub>	Turn-on delay time Rise time	$V_{DD} = 20 \text{ V}, I_D = 40 \text{ A},$ $R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$	-	20 70	-	ns ns
t <sub>d(off)</sub>	Turn-off delay time Fall time	(see Figure 15)	-	40 20	-	ns ns

Table 8. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current Source-drain current (pulsed)		-		80 320	A A
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 40 A, V <sub>GS</sub> = 0	-		1.1	V
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 80 \text{ A},$ di/dt = 100 A/ $\mu$ s, $V_{DD} = 30 \text{ V}$ (see Figure 17)	-	40 56 2.8		ns nC A

<sup>1.</sup> Pulse width limited by safe operating area

<sup>2.</sup> Pulsed: pulse duration =  $300 \mu s$ , duty cycle 1.5%

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#### 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

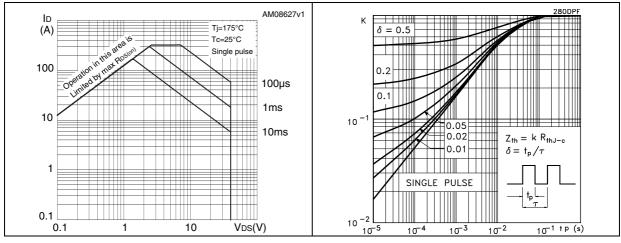


Figure 4. Output characteristics

Figure 5. Transfer characteristics

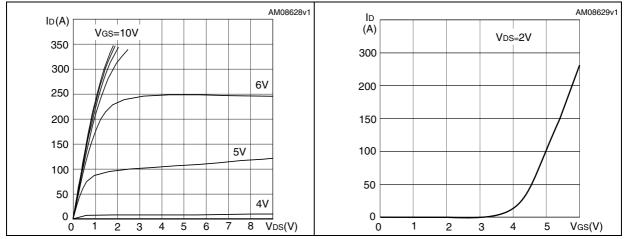
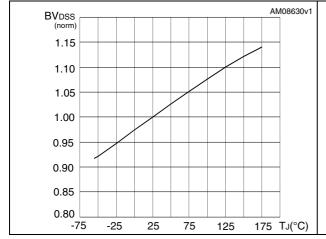
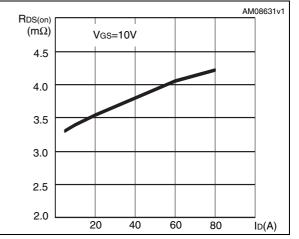


Figure 6. Normalized  $B_{VDSS}$  vs temperature Figure 7. Static drain-source on resistance





AM08632v1 AM08633v1 C (pF) Vgs (V) VDD=20V Ciss 10 ID=80A 8 1000 Coss 6 Crss 100 4 2 10 \_\_\_\_ 10 20 30 40 50 60 70 Qg(nC) 10 V<sub>DS</sub>(V) 1

Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

Figure 10. Normalized gate threshold voltage Figure 11. Normalized on resistance vs vs temperature temperature

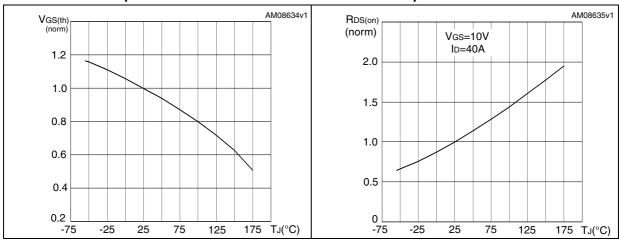
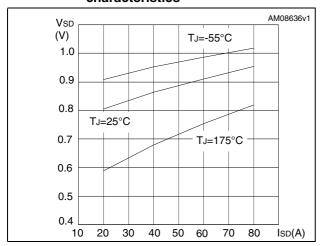


Figure 12. Source-drain diode forward characteristics



Test circuits STP120N4F6

#### 3 Test circuits

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

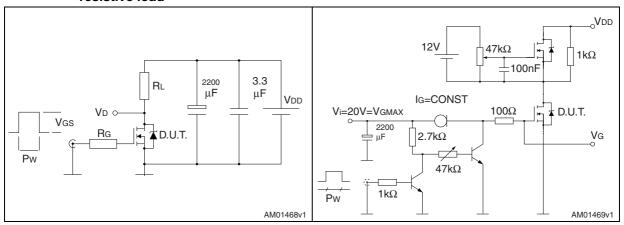


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped Inductive load test circuit

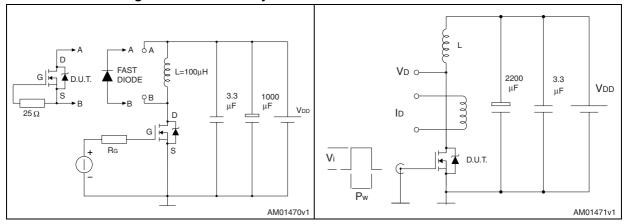
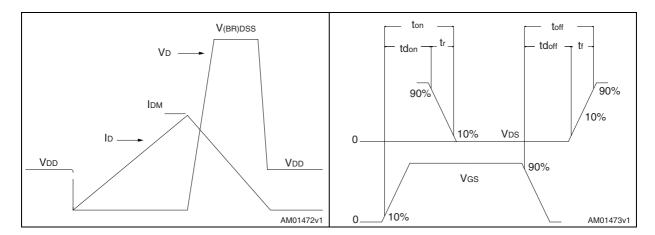


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



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# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and products status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK is an ST trademark.

Table 9. TO-220 type A mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
Α	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
С	0.48		0.70
D	15.25		15.75
D1		1.27	
Е	10		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
ØP	3.75		3.85
Q	2.65		2.95

Figure 19. TO-220 type A drawing

Revision history STP120N4F6

# 5 Revision history

Table 10. Document revision history

Date	Revision	Changes
17-May-2011	1	First release

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